TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74AC240P,TC74AC240F,TC74AC240FT TC74AC244P,TC74AC244F,TC74AC244FT

Octal Bus Buffer

TC74AC240P/F/FT Inverted, 3-State

Outputs

TC74AC244P/F/FT Non-Inverted, 3-State

Outputs

The TC74AC240 and 244 are advanced high speed CMOS OCTAL BUS BUFFERs fabricated with silicon gate and double-layer metal wiring C²MOS technology.

They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The 74AC240 is an inverting 3-state buffer while the 74AC244 is non-inverting. Both devices have two active-low output

These devices are designed to be used in such applications as 3-state memory address drivers.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

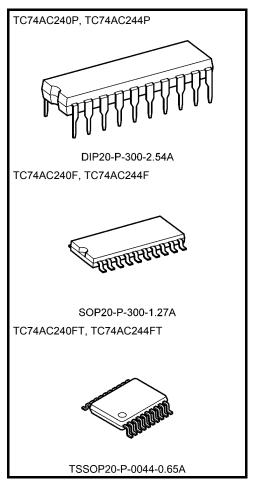
Features

- High speed: $t_{pd} = 4.0 \text{ ns (typ.)}$ at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 8 \mu A \text{ (max)}$ at $T_{a} = 25 \text{°C}$
- High noise immunity: V_{NIH} = V_{NIL} = 28% V_{CC} (min)
- Symmetrical output impedance: $|I_{OH}| = I_{OL} = 24 \text{ mA (min)}$

Capability of driving 50Ω transmission lines.

transmission

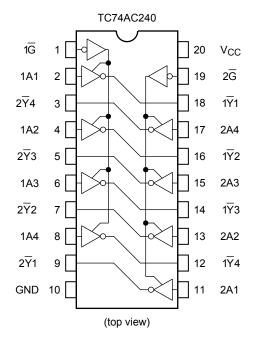
- Balanced propagation delays: t_{pLH} ≃ t_{pHL}
- Wide operating voltage range: $V_{CC \text{ (opr)}} = 2 \text{ to } 5.5 \text{ V}$
- Pin and function compatible with 74F240/244

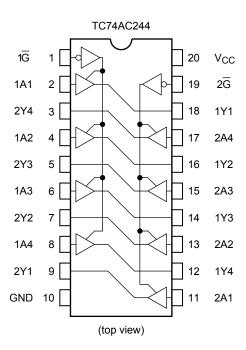


Weight

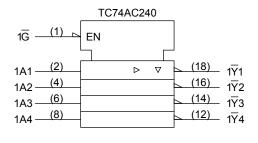
DIP20-P-300-2.54A : 1.30 g (typ.) SOP20-P-300-1.27A : 0.22 g (typ.) TSSOP20-P-0044-0.65A : 0.08 g (typ.)

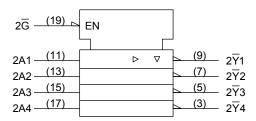
Pin Assignment

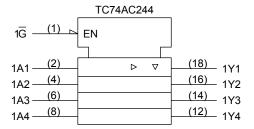


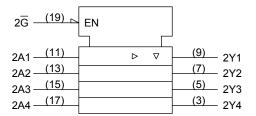


IEC Logic Symbol









Truth Table

Inputs		Outputs				
G	An	Y _n (244)	Ÿ _n (240)			
L	L	L	Н			
L	Н	Н	L			
Н	Х	Z	Z			

X: Don't care

Z: High impedance



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CC}	−0.5 to 7.0	V
DC input voltage	V _{IN}	-0.5 to V _{CC} + 0.5	V
DC output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}	±20	mA
Output diode current	lok	±50	mA
DC output current	lout	±50	mA
DC V _{CC} /ground current	I _{CC}	±200	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP/TSSOP)	mW
Storage temperature	T _{stg}	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C should be applied up to 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit	
Supply voltage	V _{CC}	2.0 to 5.5	V	
Input voltage	V _{IN}	0 to V _{CC}	V	
Output voltage	V _{OUT}	0 to V _{CC}	V	
Operating temperature	T _{opr}	−40 to 85	°C	
Input rise and fall time	dt/dV	0 to 100 (V _{CC} = 3.3 ± 0.3 V)	ns/V	
input rise and fail tille	ui/uv	0 to 20 (V _{CC} = 5 ± 0.5 V)	115/ V	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

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Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition			Ta = 25°C		Ta = -40 to 85°C		- Unit		
Sharastonistics	Cymbol			V _{CC} (V)	Min	Тур.	Max	Min	Max	OTIL	
		_		2.0	1.50	_	_	1.50	_	V	
High-level input voltage	V_{IH}			3.0	2.10	_	_	2.10	_		
					5.5	3.85	_	_	3.85	_	
		_		2.0	_	_	0.50	_	0.50		
Low-level input voltage	V_{IL}			3.0	_	_	0.90	_	0.90	V	
o de la companya de l					5.5	-	_	1.65	_	1.65	
					2.0	1.9	2.0	_	1.9	_	
			I _{OH} = -50 μA		3.0	2.9	3.0	_	2.9	_	
High-level output	Voн	V _{IN} = V _{IH} or			4.5	4.4	4.5	_	4.4	_	V
voltage		VIL	I _{OH} = -4 mA		3.0	2.58	_	_	2.48	_	V
			I _{OH} = −24 mA		4.5	3.94	_	_	3.80	_	
			I _{OH} = −75 mA	(Note)	5.5	_	_	_	3.85	_	
	VoL	V _{IN} = V _{IH} or V _{IL}			2.0	_	0.0	0.1	_	0.1	- V
			I _{OL} = 50 μA		3.0	_	0.0	0.1	_	0.1	
Low-level output					4.5	_	0.0	0.1	_	0.1	
voltage			I _{OL} = 12 mA		3.0	_	_	0.36	_	0.44	
			I _{OL} = 24 mA		4.5	_	_	0.36	_	0.44	
			I _{OL} = 75 mA	(Note)	5.5	-	_	1	_	1.65	
3-state output off-state current	I _{OZ}	V _{IN} = V _{IH} or V _{IL} V _{OUT} = V _{CC} or GND		5.5	_	_	±0.5	_	±5.0	μA	
Input leakage							_				
current	I _{IN}	$V_{IN} = V_{CC}$ or GND			5.5		_	±0.1	_	±1.0	μA
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND			5.5	_	_	8.0	_	80.0	μΑ

Note: This spec indicates the capability of driving 50 Ω transmission lines.

One output should be tested at a time for a 10 ms maximum duration.



AC Characteristics (C_L = 50 pF, R_L = 500 Ω , input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
	- ,		V _{CC} (V)	Min	Тур.	Max	Min	Max	
Propagation delay	t _{pLH}		3.3 ± 0.3	_	6.3	10.5	1.0	12.0	ns
time (Note 2)	t_{pHL}	_	5.0 ± 0.5	_	4.8	7.0	1.0	8.0	
Propagation delay	t _{pLH}	-	3.3 ± 0.3	_	7.0	11.4	1.0	13.0	ns
time (Note 3)	t_{pHL}		5.0 ± 0.5	_	5.2	7.5	1.0	8.5	
Output enable time	t _{pZL}	1	3.3 ± 0.3	_	8.4	14.0	1.0	16.0	ns
Output enable time	t _{pZH}		5.0 ± 0.5	_	5.9	8.7	1.0	10.0	
Output disable time	t _{pLZ}		3.3 ± 0.3	_	6.4	10.5	1.0	12.0	ns
	t_{pHZ}	_	5.0 ± 0.5	_	5.5	7.9	1.0	9.0	115
Input capacitance	C _{IN}	_		_	5	10	_	10	pF
Output capacitance	C _{OUT}	_		_	10	_	_	_	pF
Power dissipation capacitance	C _{PD}		(Note 1)	_	30	_	_	_	pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

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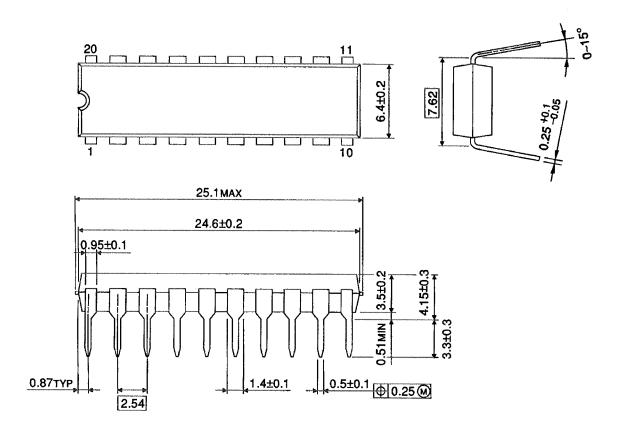
Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 (per bit)$

Note 2: For TC74AC240 only Note 3: For TC74AC244 only

Package Dimensions

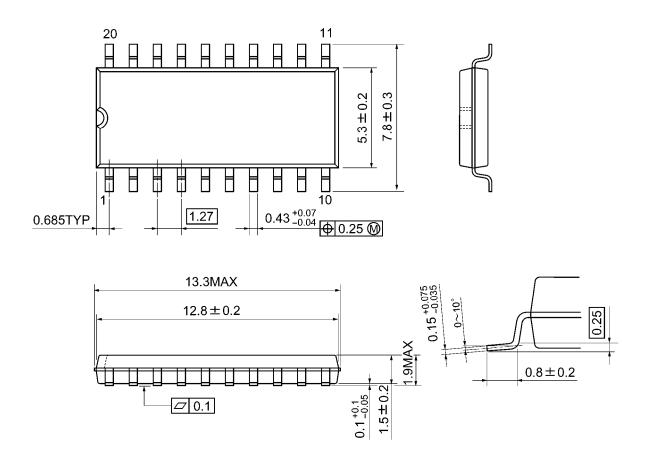
DIP20-P-300-2.54A Unit: mm



Weight: 1.30 g (typ.)

Package Dimensions

SOP20-P-300-1.27A Unit: mm

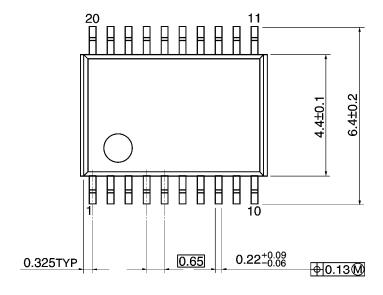


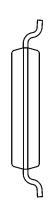
Weight: 0.22 g (typ.)

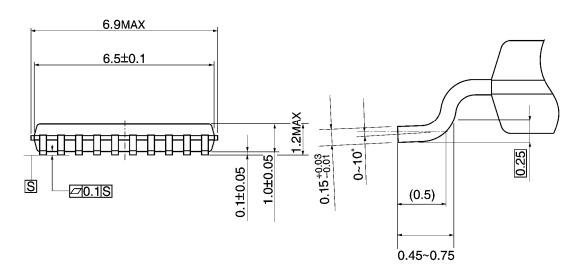
Package Dimensions

TSSOP20-P-0044-0.65A

Unit: mm







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Weight: 0.08 g (typ.)



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